

FEATURES

- LOW INDUCTANCE (≤5nH)
- 0.5mΩ ~ 8.0mΩ RESISTANCE RANGE
- RESISTOR TOLERANCES DOWN TO ±0.5%
- LOW TCR OPTIONS DOWN TO ≤±50 PPM/°C
- HIGH POWER CAPABILITY
- AEC-Q200 QUALIFIED AVAILABLE
- OPERATING TEMPERATURE UP TO 170°C
- POWER RATINGS UP TO 5.0 WATT
- LOW EMF (< 3 mV/°C)

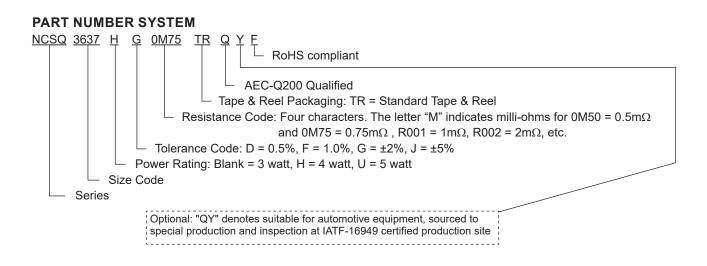
SPECIFICATIONS

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Туре	EIA Size	Power Rating & Code At 70°C	TCR (PPM/°C) See Note #1	Element TCR (PPM/°C) See Note #2	Max.*1 Current Rating	Max.*2 Overload Current	Resistance Range 0.5% (D), 1% (F)	Temperature Range
							2% (G), 5% (J)	
NCSQ3637		3W		0.5m0 <====	77.46	173.21	0.5mΩ ~ 8.0mΩ	
	3637	4W (H)	<u><</u> ±50ppm	$0.5m\Omega \leq \pm 10$ ppm	89.44	200	0.5mΩ ~ 1.0mΩ	-55 °C ~ +170 °C
		5W (U)	0.75mΩ ~ 8.0mΩ <u><</u> ±30		100	223.61	0.5002 ~ 1.0002	

1. Component TCR - Total TCR that includes the TCR effects of the resistor element and the copper terminal and soldering.

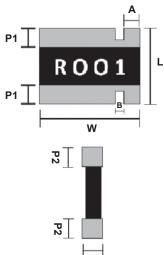
2. Element TCR - Only applies to the alloy used for the resistor element; refer to note1 for component temperature coefficient (including copper terminal).



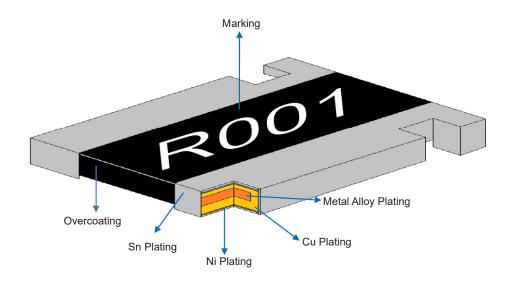


COMPONENT DIMENSIONS (mm)

Туре	EIA Size	Power Rating @ 70°C	Resistance Values	Temp. Range	L	w	A	в	т	P1	P2	
			0.5mΩ									
			0.75mΩ		9.140 ±0.254	9.600 ±0.254	1.50 ±0.254	1.20 ±0.254	0.73 ±0.254	2.35 ±0.254	2.20 ±0.254	
		3W	1mΩ	-55 °C ~ +170 °C								
			2mΩ									
	3637		3mΩ									
NCSQ3637			5mΩ								2.15 ±0.254	
			6mΩ									
			8mΩ									
			0.5mΩ									
		4W/ 5W	0.75mΩ								2.20 ±0.254	
			1mΩ								20.204	



CONSTRUCTION



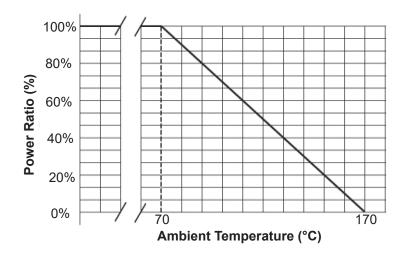


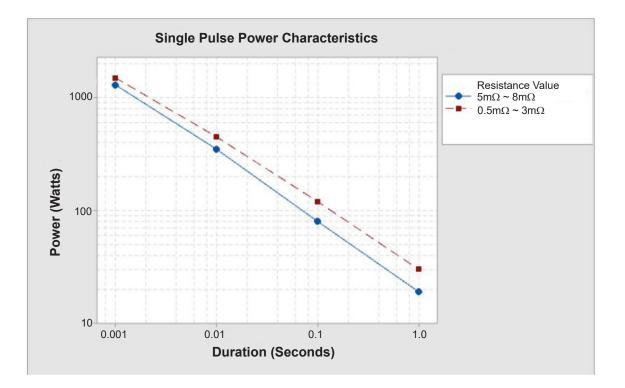
Rated Current: The following equation may be used to determine the DC (Direct Current) or AC (Alternating Current) (RMS, root mean square value) of normal rated power. However, if the result value exceeds the max. current rating, the highest normal rated power is to be used.

Rated Current (Amps): // Power rating (Watts) / Resistance (Ohms)

Power Derating Curve: Operating Temperature Range -55°C ~+170°C)

For operation at ambient temperature in excess of 70°C, the load should be derated in accordance with the power derating curve below.



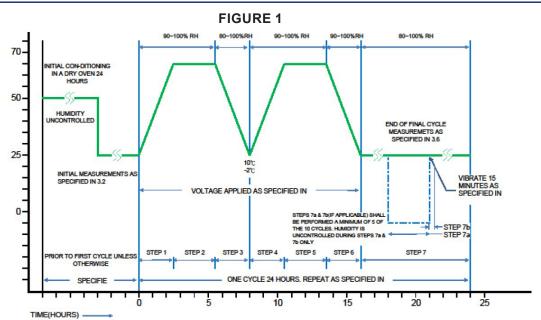




ENVIRONMENTAL CHARACTERISTICS

Item	Requirement	Test Method*
Temperature Coefficient of Resistance	As specified	JIS-C-5201-1 4.8 IEC-60115-1 4.8 +25/+150°C +25°C is the reference temperature
Short Time Overload	ΔR/R1 ≤ ± (0.5% +0.0005Ω)	JIS-C-5201-1 4.13 IEC-60115-1 4.13 3W: 5 times of rated power for 5 second 4W: 5 times of rated power for 5 second 5W: 5 times of rated power for 5 second
High Temperature Exposure	ΔR/R1 ≤ ± (1.0% +0.0005Ω)	JIS-C-5201-1 4.25, IEC-60068-2-2 At 170±5°C for 1000 hours.
Resistance to Soldering Heat	$\Delta R/R1 \le \pm (0.5\% \pm 0.0005\Omega)$. No visual damage	JIS-C-5201-1 4.18 IEC-60115-1 4.18 260±5°C for 10 seconds.
Temperature Cycling	ΔR/R1 ≤ ± (0.5% +0.0005Ω)	JESD22 Method JA-104 1000 Cycles (-55°C to +155°C) Measurement at 24±4 hours after test conclusion. 30min maximum dwell time at each temperature extreme.
Biased Humidity	ΔR/R1 ≤ ± (0.5% +0.0005Ω)	MIL-STD-202 Method 103 1,000 hours; 85°C/85% RH, 10% of operating power. Measurement at 24±4 hours after test conclusion.
Load Life (Endurance)	For $\leq 3m\Omega$: ΔR/R1 $\leq \pm (1.0\% + 0.0005\Omega)$ For 5mΩ /6mΩ /8mΩ: ΔR/R1 $\leq \pm (2.0\% + 0.0005\Omega)$	JIS-C-5201-1 4.25 IEC-60115-1 4.25.1 70±2°C, RCWV or Max. working voltage whichever is less for 1000 hrs with 1.5 hrs "ON"and 0.5 hr "OFF"
Solderability	>95% Coverage. No visual damage	JIS-C-5201-1 4.17 IEC-60115-1 4.17 245±5°C for 3 seconds.
Dielectric Withstanding Voltage	No broken	JIS-C5201-1 4.7 Apply 500VAC for 1 minute.
Core Body Strength	∆R/R1 <u>≤</u> ± (0.5% +0.0005Ω) No broken	JIS-C5201-1 4.15 Central part pressurizing force: 5N,10 seconds
Terminal Strength (SMD)	ΔR/R1 ≤± (0.5% +0.0005Ω)	AEC Q200-006 Pressurizing force 17.7N for 60 seconds
Bending Strength	ΔR/R1 ≤± (0.5% +0.0005Ω)	JIS-C-5201-1 4.33 IEC-60115-1 4.33 Bending once 2mm for 10 seconds
Moisture Resistance	ΔR/R1 <u>≤</u> ± (0.5% +0.0005Ω)	MIL-STD 202 Method 106 T=24 hours / Cycle ,10Cycles . Steps 7a& 7b not required. Unpowered. (Figure 1)





TEMP (°C)

First Wave

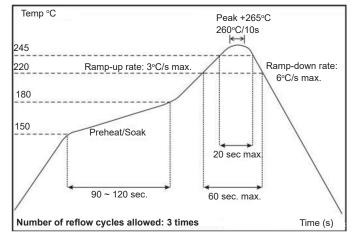
≈ -200K/s

265

235

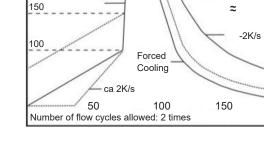
RECOMMENDED SOLDERING PROFILES

REFLOW SOLDERING PROFILE



LAND PATTERN DIMENSIONS (mm)

Power Rating	Resistance Range	а	b	С	d	e	
3W	0.5mΩ ~ 8.0mΩ	3.30	10.5	1.98	0.60	4.00	
4W & 5W	& 5W 0.5mΩ ~ 1.0mΩ		10.5	1.90	0.00	4.00	

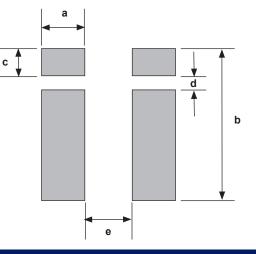


WAVE SOLDERING PROFILE

260°C/10s

Second Wave

≈ -5K/s



Typical values (solid line)

Process limits (dotted line)

200

Time (sec.)

25

Performance Passives By Design

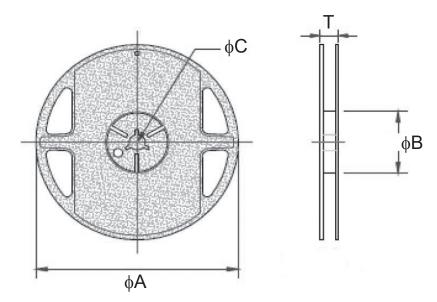
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TAPING SPECIFICATIONS

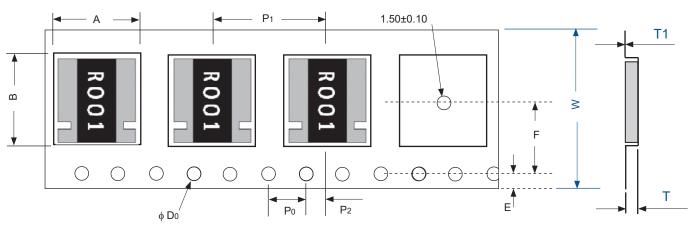
Туре	EIA Size	А	В	С	т	Paper Tape (EA)
NCSQ3637	3637	178 ±1.0	60.0±1.0	13.5 ±0.5	17.4 ±1.0	1,000





EMBOSSED CARRIER DIMENSIONS (mm)

Туре	EIA Size	А	В	φD ₀	E	F	P ₀	P ₁	P ₂	W	т	T ₁
NCSQ3637	3637	9.6 ± 0.1	10.0 ± 0.1	1.50 +1/-0	1.75 ± 0.1	7.5 ±0.1	4.00 ± 0.1	12.00 ± 0.1	2.00 ±0.1	16.00 ± 0.20	1.3 ±0.1	0.25 ± 0.05



Direction of unreeling